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Advances in Magnetic Materials: Fabrication, Properties, and Applications

Guest Editor:

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Deadline for manuscript submissions: closed (20 November 2023)

Message from the Guest Editor

Dear Colleagues,

Magnetic materials have been intensively studied for several decades, particularly as applied to data storage. Since the advent of spintronics late last century, the applications have been extended to non-volatile memory. This Special Issue will address recent applications of magnetic materials to data storage and advanced memory. It will comprise select contributed papers on the fabrication, properties and applications of magnetic materials.

Potential topics include, but are not limited to: perpendicular magnetic anisotropy thin films; fabrication of magnetic tunnel junctions; characterization of the magnetic and structural properties of magnetic tunnel junctions; bit-patterned media for hard disk drives; block copolymer templating of high-coercivity perpendicular thin films; rare-earth-free high-magnetic-strength thin films.

Prof. Dr. Subhadra Gupta *Guest Editor*









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Editor-in-Chief

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Message from the Editor-in-Chief

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